

UNISONIC TECHNOLOGIES CO., LTD

2N7002KW **Power MOSFET**

300mA, 60V N-CHANNEL **ENHANCEMENT MODE MOSFET**

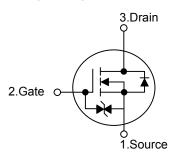


The UTC 2N7002KW uses advanced technology to provide excellent R_{DS(ON)}, low gate charge and low gate voltages during operation. This device is suitable for use as a load switch or in PWM applications.

FEATURES

- * Low Reverse Transfer Capacitance (C_{RSS} = typical 3.0 pF)
- * ESD Protected
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, High Ruggedness

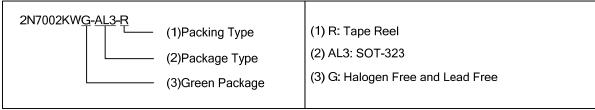
SYMBOL



ORDERING INFORMATION

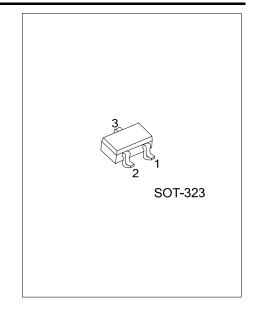
Ordering Number	Package	Pin Assignment			Dooking	
		1	2	3	Packing	
2N7002KWG-AL3-R	SOT-323	S	G	D	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING





www.unisonic.com.tw 1 of 4

■ ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified.)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	60	V	
Gate-Source Voltage		V_{GSS}	±20	V	
Drain Current	Continuous	I _D	300	mA	
	Pulse(Note 2)		800		
Power Dissipation		Б	200	mW	
Derating above T _A =25°C		P _D	1.6	mW/°C	
Junction Temperature		T_J	+150	Ĉ	
Storage Temperature		T _{STG}	-55 ~ +150	°C	

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ ELECTRICAL CHARACTERISTICS (T_A=25°C, unless otherwise specified.)

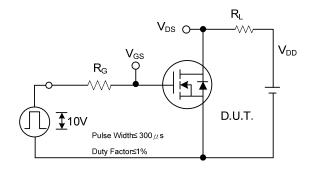
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT			
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS} =0V, I_D =10 μ A	60			V			
Drain-Source Leakage Current	I_{DSS}	V _{DS} =60V, V _{GS} =0V			1.0	μA			
Gate-Source Leakage Current	I_{GSS}	V_{DS} =0V, V_{GS} =±20V			±10	μA			
ON CHARACTERISTICS									
Gate Threshold Voltage	$V_{GS(TH)}$	V _{DS} =10V, I _D =1mA	1.0	1.85	2.5	V			
Static Drain-Source On-Resistance (Note)	R _{DS(ON)}	V _{GS} =10V, I _D =300m A			2	Ω			
		V_{GS} =4.5V, I_D =200mA			4	12			
DYNAMIC PARAMETERS									
Input Capacitance	C _{ISS}			25	50	pF			
Output Capacitance	Coss	V _{DS} =25V, V _{GS} =0V, f=1.0MHz		10	25	pF			
Reverse Transfer Capacitance	C_{RSS}			3.0	5.0	pF			
SWITCHING PARAMETERS									
Turn-ON Delay Time	$t_{D(ON)}$	I_D =0.2 A, V_{DD} =30V, V_{GS} =10V,		12	20	ns			
Turn-OFF Delay Time	t _{D(OFF)}	R_L =150 Ω , R_G =10 Ω		20	30	ns			
DRAIN-SOURCE DIODE CHARACTERIST	ICS AND MA	XIMUM RATINGS							
Drain-Source Diode Forward Voltage	V_{SD}	V _{GS} =0V, Is=300mA (Note)		0.88	1.5	V			
Maximum Pulsed Drain-Source Diode	I_{SM}				0.8	Α			
Forward Current	ISM				0.0	^			
Maximum Continuous Drain-Source Diode	Is				300	mA			
Forward Current	18				300	111/			

Notes: 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch. Minimum land pad size.

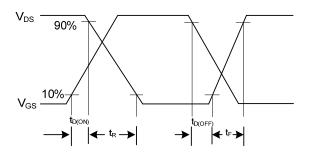
^{2.} Pulse width \leq 300 μ s, Duty cycle \leq 1%

2N7002KW Power MOSFET

■ TEST CIRCUITS AND WAVEFORMS

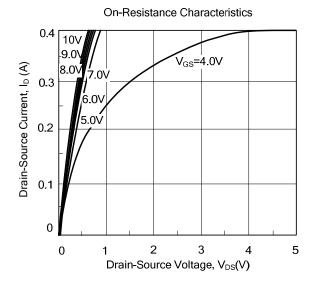


Switching Test Circuit



Switching Waveforms

TYPICAL CHARACTERISTICS



UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice.